

LINEAR TECHNOLOGY MATERIALS DECLARATION

1t5514efe#trpbf

(Engineering Calculation)

TSSOP Exp. Pad

(printed on: 2020-07-11 18:51:21)

TOTAL MASS (g) : 0.071895

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.002777	1000000	38625.59375		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.024424	975000	339716.0625		
		Iron (Fe)	7439-89-6	0.000601	24000	8359.37402344		
		Phosphorus (P)	7723-14-0	0.000008	300	111.272872925		
		Zinc (Zn)	7440-66-6	0.000018	700	250.363983154		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
Lead Frame Total:				0.025051	1000000	348437.0625		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.001770	1000000	24623.6992188		
		External Plating Total:				0.001770	1000000	24623.6992188
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000683	1000000	9499.921875		
		Internal Plating Total:				0.000683	1000000	9499.921875
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000856	750000	11906.1972656		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000285	250000	3964.09594727		
Die Attach Total:				0.001141	1000000	15870.2939453		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.006015	150000	83663.2890625		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.032882	820000	457359.34375		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.001002	25000	13936.9267578		
		Carbon Black (C)	1333-86-4	0.000201	5000	2795.73095703		
		Encapsulation Total:				0.040100	1000000	557755.3125
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000373	1000000	5188.09765625		
					TOTAL MASS (g) :	0.071895		